

200mW SOD- 323 Fast Switching Diode

Features

- 50nS; Fast Switching Device (TRR <50 nS)
- 200mW; Power Dissipation of 200mW
- High Stability and High Reliability
- Low reverse leakage

Pb RoHS COMPLIANT



 $\textbf{Marking}_{:JS} \ \textbf{SOD-323}$

Mechanical Data

- SOD-323 Small Outline Plastic Package
- Polarity: Color band denotes cathode end
- Mounting Position: Any

Maximum Ratings& Thermal Characteristics (T _A =25°C unless otherwise noted)					
Parameters	Symbol	Value	Unit		
Reverse Voltage	V _R	250	V		
Peak Reverse Voltage	V_{RRM}	250	V		
Power Dissipation	P _D	200	mW		
Operating junction temperature	T _J	150	$^{\circ}$ C		
Storage temperature range	Ts	-55-+150	$^{\circ}$		
Thermal Resistance from Junction to Ambient	R ₀ JA	635	°C/W		
Average Rectified Current	Io	200	mA		
Peak Forward Surge Cu rrent @tp=1us; TA=25 ℃	I _{FSM}	625	mA		

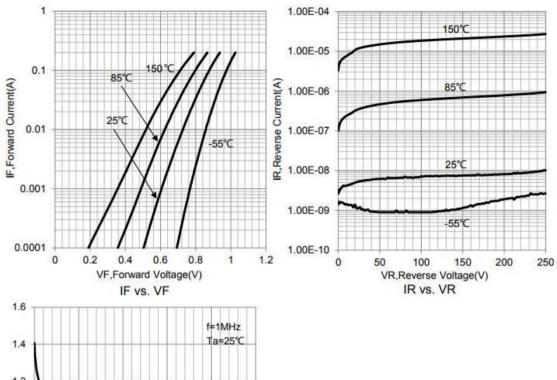
Valid provided that electrodes are kept at ambient temperature.

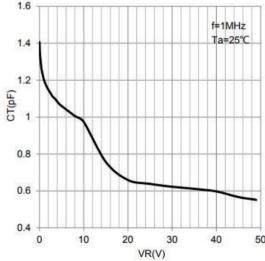
Electrical Characteristics (T _A =25°C unless otherwise noted)					
Parameter		Test Condition	Limits		
	Symbols		Min	Max	Unit
Reverse Voltage	V _(BR)	IR=100uA	250		V
Reverse Leakage Current	lR	VR=200V		1	uA
Forward Voltage V _F	VF	IF=100mA		1.00	V
		IF=200mA		1.25	V
Reverse Recovery Time	TRR	$ \begin{aligned} & \text{IF} = \text{IR} = 30\text{mA}, \\ & \text{Irr} = 0.1\text{XIR} \\ & \text{RL} = 100 \ \Omega \end{aligned} $		50	nS
Capacitance	Cj	VR=0V, f=1MHZ		5.0	pF



Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)





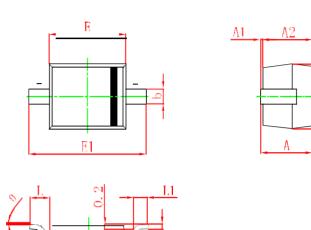
CT vs. VR





Package Outline Dimensions

millimeters



Symbol	Min	Max
Α		1.000
A 1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
С	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
L	0.475REF	
L1	0.250	0.400
θ	00	80

Revision History

Document Version	Date of release	Description of changes
Rev.A	2018.01.12	First issue





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